

REVISIONS

LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Remove vendor CAGE 13919. Add device type 02. Add vendors CAGE 31757 and 60024. Change to reflect MIL-H-38534 processing. Editorial changes throughout.	91-09-13	Tim H. Noh
B	Table I, device type 01, correct output voltage peak and output current peak tests.	00-01-11	Raymond Monnin
C	Drawing updated to reflect current requirements. -sld	02-12-16	Raymond Monnin
D	Figure 1, case outline X, dimension C, delete 0.260" minimum and change 0.300" maximum to 0.340" maximum.	03-09-25	Raymond Monnin

THE ORIGINAL FIRST SHEET OF THIS DRAWING HAS BEEN REPLACED.

REV																			
SHEET																			
REV																			
SHEET																			
REV STATUS OF SHEETS	REV	D	D	D	D	D	D	D	D	D	D	D	D	D	D				
	SHEET	1	2	3	4	5	6	7	8	9	10	11	12						
PMIC N/A	PREPARED BY Gary Zahn	<p align="center">DEFENSE SUPPLY CENTER COLUMBUS POST OFFICE BOX 3990 COLUMBUS, OHIO 43216-5000 http://www.dscc.dla.mil</p> <p align="center">MICROCIRCUIT, HYBRID, LINEAR, HIGH POWER OPERATIONAL AMPLIFIER</p>																	
<p align="center">STANDARD MICROCIRCUIT DRAWING</p> <p align="center">THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE</p> <p align="center">AMSC N/A</p>	CHECKED BY Steve Duncan																		
	APPROVED BY Tim H. Noh																		
	DRAWING APPROVAL DATE 87-09-16																		
	REVISION LEVEL D	SIZE A	CAGE CODE 67268	5962-87620															
		SHEET		1 OF 12															

1. SCOPE

1.1 Scope. This drawing documents one product assurance class, class H (high reliability) and a choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN).

1.2 PIN. The PIN shall be as shown in the following example:



1.2.1 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	42106, PA51M/883	High power operational amplifier
02	42106-1, PA51M/883	High power operational amplifier

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
X	See figure 1	8	Flange mount
Y	See figure 1	8	Flange mount

1.2.3 Lead finish. The lead finish shall be as specified in MIL-PRF-38534.

1.3 Absolute maximum ratings.

Supply voltage range.....	±40 V dc maximum
Differential input voltage.....	±V _{CC} - 3 V
Common mode input.....	±V _{CC}
Maximum power dissipation (P _D):	
Device type 01	80 W <u>1/</u>
Device type 02	97 W <u>2/</u>
Thermal resistance, junction-to-case (θ _{JC}):	
Device type 01	2.2°C/W
Device type 02	1.8°C/W
Junction temperature (T _J)	+200°C
Lead temperature (soldering, 10 seconds).....	+300°C
Storage temperature range	-65°C to +150°C

1.4 Recommended operating conditions.

Supply voltage (±V _{CC}).....	±34 V dc
Operating temperature range:	
Device type 01 (T _A)	-55°C to +125°C
Device type 02 (T _C)	-55°C to +125°C

1/ At ambient temperature of +25°C, derate at 2.2°C/W above ambient temperature of +25°C.

2/ At case temperature of +25°C, derate at 1.8°C/W above case temperature of +25°C.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A	REVISION LEVEL D	5962-87620 SHEET 2
---	------------------	----------------------------	--

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38534 - Hybrid Microcircuits, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.
 MIL-STD-1835 - Interface Standard For Electronic Component Case Outlines.

HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).
 MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item performance requirements for device class H shall be in accordance with MIL-PRF-38534. Compliance with MIL-PRF-38534 may include the performance of all tests herein or as designated in the device manufacturer's Quality Management (QM) plan or as designated for applicable device class. Therefore, the tests and inspections herein may not be performed for applicable device class (see MIL-PRF-38534). Furthermore, the manufacturers may take exceptions or use alternate methods to the tests and inspections herein and not perform them. However, the performance requirements as defined in MIL-PRF-38534 shall be met for the applicable device class. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38534 and herein.

3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.2 herein and on figure 1.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 2.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full specified operating temperature range.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 3

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.

3.5 Marking of device(s). Marking of device(s) shall be in accordance with MIL-PRF-38534. The device shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's vendor similar PIN may also be marked.

3.6 Data. In addition to the general performance requirements of MIL-PRF-38534, the manufacturer of the device described herein shall maintain the electrical test data (variables format) from the initial quality conformance inspection group A lot sample, for each device type listed herein. Also, the data should include a summary of all parameters manually tested, and for those which, if any, are guaranteed. This data shall be maintained under document revision level control by the manufacturer and be made available to the preparing activity (DSCC-VA) upon request.

3.7 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to supply to this drawing. The certificate of compliance (original copy) submitted to DSCC-VA shall affirm that the manufacturer's product meets the performance requirements of MIL-PRF-38534 and herein.

3.8 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38534 shall be provided with each lot of microcircuits delivered to this drawing.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38534 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38534. The following additional criteria shall apply:

- a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition B or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}\text{C}$ minimum for device type 01 and $T_C = +125^{\circ}\text{C}$, minimum for device type 02.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 4

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C ±V _{CC} = ±34 V dc unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Input offset voltage	V _{IO}	T _A = +25°C	1	01	-5	+5	mV
Input offset voltage drift	DV _{IO}	T _A = -55°C and +125°C	2, 3	01	-40	+40	μV/°C
Input bias current	I _{IB}		1	01	-20	+20	nA
			2, 3		-35	+35	
Input offset current	I _{IO}		1	01	-3	+3	nA
			2, 3		-7	+7	
Power supply rejection ratio	+PSRR	-V _{CC} = -34 V dc, +V _{CC} = +10 V to +40 V dc	1	01	-100	+100	μV/V
			2, 3		-200	+200	
	-PSRR	+V _{CC} = +34 V dc, -V _{CC} = -10 V to -40 V dc	1		-100	+100	
			2, 3		-200	+200	
Common mode rejection ratio	CMRR	V _{CM} = ±22 V, f = dc	1	01	80		dB
			2, 3		76		
Supply current	I _{CC}	V _{CM} = 0 V, no load Condition	1, 2, 3	01	-10	+10	mA
Output voltage peak	V _{OP}	I _O = 10 A peak	4	01		-26	V
		I _O = 10 A peak	4		26		
		R _L = 10 kΩ	5, 6			-30	
		R _L = 10 kΩ	5, 6		30		
Output current peak	I _{OP}	R _L = 2.6 Ω, T _A = +25°C	4	01	10		A
Voltage gain	A _{VS}	R _L = 10 kΩ	4, 5, 6	01	94		dB
Slew rate	SR	R _L = 6.5 Ω, T _A = +25°C	4	01	1.35		V/μs

**STANDARD
MICROCIRCUIT DRAWING**
DEFENSE SUPPLY CENTER COLUMBUS
COLUMBUS, OHIO 43216-5000

SIZE
A

REVISION LEVEL
D

5962-87620

SHEET
5

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 1/ -55°C ≤ T _C ≤ +125°C ±V _{CC} = ±34 V dc unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Supply current	I _S	V _{IN} = 0 V dc, G = 100, 2/ ±R _{CL} = 0.1 Ω, V _{CM} = 0 V dc	1, 3	02		10	mA
			2			13	
Input offset voltage	V _{OS}	V _{IN} = 0 V dc, G = 100, 2/ ±R _{CL} = 0.1 Ω, ±V _{CC} = ±10 V dc	1	02	-16.0	+16.0	mV
			2		-22.5	+22.5	
			3		-21.2	+21.2	
			1		-10.0	+10.0	
			2		-16.5	+16.5	
			3		-15.2	+15.2	
		V _{IN} = 0 V dc, G = 100, 2/ ±R _{CL} = 0.1 Ω, ±V _{CC} = ±34 V dc	1	-11.2	+11.2		
			2	-17.7	+17.7		
			3	-16.7	+16.7		
			1	-11.2	+11.2		
			2	-17.7	+17.7		
			3	-16.7	+16.7		
Input bias current (+IN)	+I _S	V _{IN} = 0 V dc, R _{BIAS} ≤ 100 MΩ	1	02		40.0	nA
			2, 3			80.0	
Input bias current (-IN)	-I _S	V _{IN} = 0 V dc, R _{BIAS} ≤ 100 MΩ	1	02		40.0	nA
			2, 3			80.0	
Input offset current	I _{OS}	V _{IN} = 0 V dc, R _{BIAS} ≤ 100 MΩ	1	02		10.0	nA
			2, 3			30.0	
Output voltage	V _O	±V _{CC} = ±40 V dc, I _O = 68 mA, R _L = 500 Ω	4, 5, 6	02	34		V
		±V _{CC} = ±34 V dc, I _O = 4 A, R _L = 6 Ω	4, 5, 6		24		
		±V _{CC} = ±18 V dc, I _O = 10 A, R _L = 1 Ω, T _C = +25°C and -55°C	4, 6		10		
		±V _{CC} = ±16 V dc, I _O = 8 A, R _L = 1 Ω, T _C = +125°C	5		8		

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 6

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions <u>1/</u> -55°C ≤ T _C ≤ +125°C ±V _{CC} = ±34 V dc unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Current limits	I _{CL}	±V _{CC} = ±16 V dc, ±R _{CL} = 0.1 Ω, R _L = 1 Ω, T _C = +25°C <u>2/</u>	4	02	5.0	7.9	A
Stability/noise	E _N	±V _{CC} = ±34 V dc, C _L = 1.5 nF, G = 1	4, 5, 6	02		1.0	mV
Slew rate	S _R	±V _{CC} = ±34 V dc, V _{IN} ≥ 4 Vp-p, R _L = 500 Ω	4, 5, 6	02	1.0	10	V/μs
Open loop gain	A _{OL}	±V _{CC} = ±34 V dc, V _{IN} ≥ 4 Vp-p, R _L = 500 Ω, f = 15 Hz	4, 5, 6	02	91		dB
Common mode rejection	CMR	±V _{CC} = ±15 V dc, V _{CM} = ±9 V dc, +f = dc	4, 5, 6	02	70		dB

1/ During all group A testing, terminal connection F. O. (pin 7) is left open.

2/ A current limiting resistor (R_{CL}) is connected between C_L+ to the output and C_L- to the output during these tests.

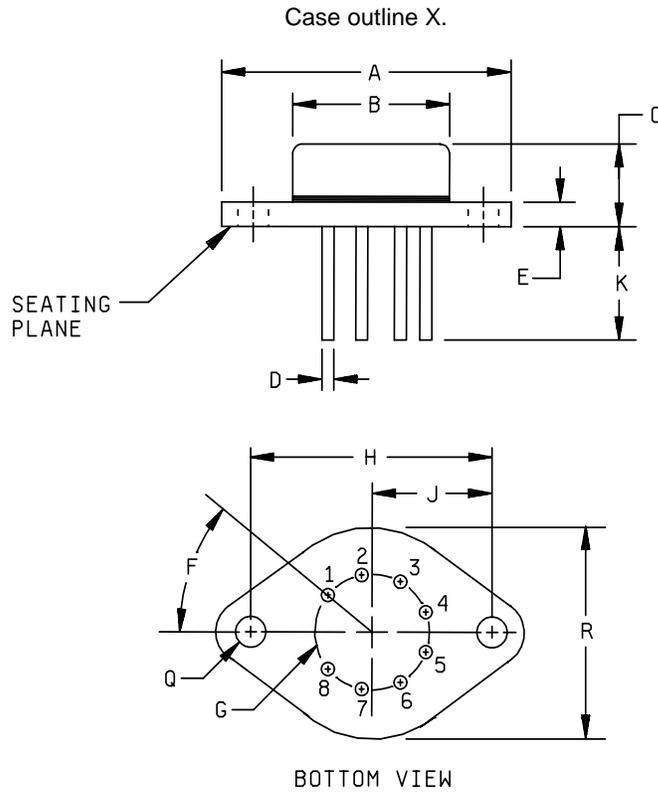
**STANDARD
MICROCIRCUIT DRAWING**
DEFENSE SUPPLY CENTER COLUMBUS
COLUMBUS, OHIO 43216-5000

SIZE
A

5962-87620

REVISION LEVEL
D

SHEET
7



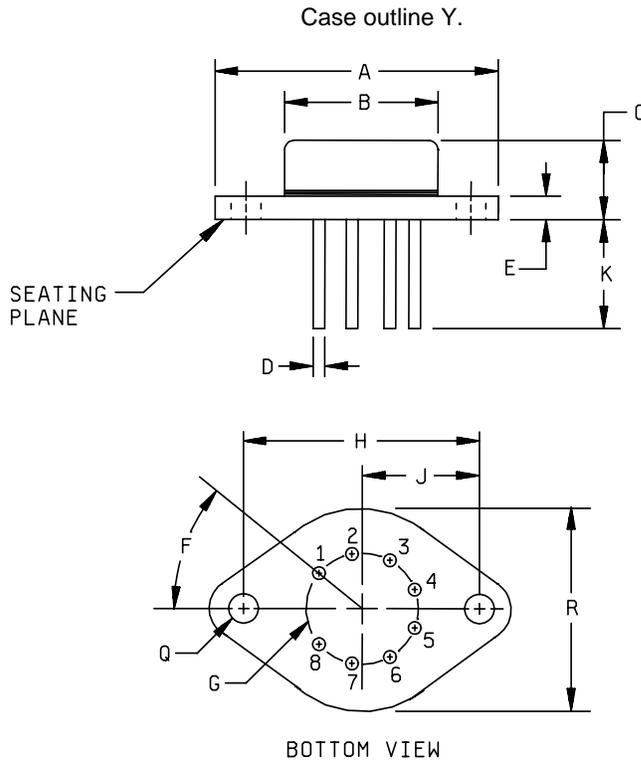
Symbol	Inches		Millimeters	
	Min	Max	Min	Max
A	1.510	1.550	38.35	39.37
B	0.745	0.770	18.92	19.56
C		0.340		8.64
D	0.038	0.042	.97	1.07
E	0.080	0.105	2.03	2.67
F	40° BSC		40° BSC	
G	0.500 BSC		12.7 BSC	
H	1.186 BSC		30.12 BSC	
J	0.593 BSC		15.06 BSC	
K	0.400	0.500	10.16	12.70
Q	0.151	0.161	3.84	4.09
R	0.980	1.020	24.89	25.91

NOTES:

1. Leads in true position within .010 inch (0.25 mm) R at MMC at seating plane.
2. The U. S. preferred system of measurement is the metric SI. This case outline was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound shall take precedence.
3. Pin numbers are for reference and may not be marked on package.

FIGURE 1. Case outline(s).

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 8



Symbol	Inches		Millimeters	
	Min	Max	Min	Max
A	1.510	1.550	38.35	39.37
B	0.745	0.770	18.92	19.56
C	0.225	0.250	5.71	6.35
D	0.038	0.042	.97	1.07
E	0.080	0.105	2.03	2.67
F	40° BSC		40° BSC	
G	0.500 BSC		12.7 BSC	
H	1.186 BSC		30.12 BSC	
J	0.593 BSC		15.06 BSC	
K	0.400	0.500	10.16	12.70
Q	0.151	0.161	3.84	4.09
R	0.980	1.020	24.89	25.91

NOTES:

1. Leads in true position within .010 inch (0.25 mm) R at MMC at seating plane.
2. The U. S. preferred system of measurement is the metric SI. This case outline was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound shall take precedence.
3. Pin numbers are for reference and may not be marked on package.

FIGURE 1. Case outline(s) - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 9

Device types	01 and 02
Case outlines	X and Y
Terminal number	Terminal symbol
1	Output
2	+Current limit (C_{L+})
3	+ V_{CC}
4	+IN
5	-IN
6	- V_{CC}
7	No connection
8	-Current limit (C_{L-})

FIGURE 2. Terminal connections.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 10

TABLE II. Electrical test requirements.

MIL-PRF-38534 test requirements	Subgroups (in accordance with MIL-PRF-38534, group A test table)
Interim electrical parameters	1
Final electrical parameters	1*, 2, 3, 4, 5, 6
Group A test requirements	1, 2, 3, 4, 5, 6
Group C end-point electrical parameters	1

* PDA applies to subgroup 1.

4.3 Conformance and periodic inspections. Conformance inspection (CI) and periodic inspection (PI) shall be in accordance with MIL-PRF-38534 and as specified herein.

4.3.1 Group A inspection (CI). Group A inspection shall be in accordance with MIL-PRF-38534 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 7, 8, 9, 10, and 11 shall be omitted.

4.3.2 Group B inspection (PI). Group B inspection shall be in accordance with MIL-PRF-38534.

4.3.3 Group C inspection (PI). Group C inspection shall be in accordance with MIL-PRF-38534 and as follows:

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test, method 1005 of MIL-STD-883.
 - (1) Test condition B or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
 - (2) $T_A = +125^\circ\text{C}$ minimum for device type 01 and $T_C = +125^\circ\text{C}$, minimum for device type 02.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.3.4 Group D inspection (PI). Group D inspection shall be in accordance with MIL-PRF-38534.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38534.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 11

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-PRF-38534.

6.4 Record of users. Military and industrial users shall inform Defense Supply Center Columbus when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 Comments. Comments on this drawing should be directed to DSCC-VA, P. O. Box 3990, Columbus, Ohio 43216-5000, or telephone (614) 692-1081.

6.6 Sources of supply. Sources of supply are listed in MIL-HDBK-103 and QML-38534. The vendors listed in MIL-HDBK-103 and QML-38534 have submitted a certificate of compliance (see 3.7 herein) to DSCC-VA and have agreed to this drawing.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-87620
		REVISION LEVEL D	SHEET 12

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 03-09-25

Approved sources of supply for SMD 5962-87620 are listed below for immediate acquisition only and shall be added to MIL-HDBK-103 and QML-38534 during the next revision. MIL-HDBK-103 and QML-38534 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38534.

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
5962-8762001XA 5962-8762001XC 5962-8762001YA	31757 31757 60024	42106 42106 PA51M/883
5962-8762002XA 5962-8762002XC 5962-8762002YA	31757 31757 60024	42106-1 42106-1 PA51M/883

- 1/ The lead finish shown for each PIN, representing a hermetic package, is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

Vendor name
and address

31757

Micropac Industries, Incorporated
905 East Walnut Street
Garland, TX 75040
Point of contact: Microcircuit Division

60024

Apex Microtechnology Corporation
5980 North Shannon Road
Tucson, AZ 85741

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.